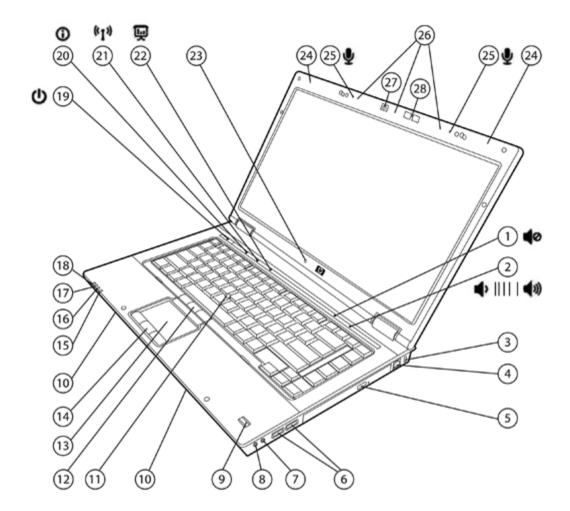
Overview



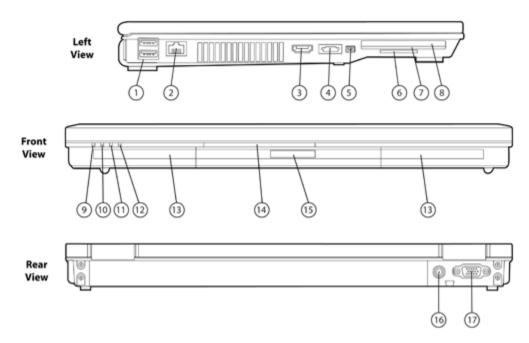


- 1. Volume mute button with LED indicator
- 2. Volume scroll zone with up/down LED indicators
- 3. Kensington Lock slot
- 4. RJ-11/modem port
- 5. Upgrade Bay (optical drive or second hard drive)
- 6. 2 USB 2.0 ports
- 7. Stereo microphone in
- 8. Stereo headphone/line out
- 9. HP Fingerprint Sensor
- 10. Integrated stereo speakers
- 11. Pointstick
- 12. Pointstick buttons, three
- 13. Touchpad with scroll zone
- 14. Touchpad buttons, three

- 15. Hard drive / optical drive activity / HP 3D DriveGuard LED
- 16. Battery charging LED
- 17. Power/standby LED
- 18. Wireless on/off LED
- 19. Power button with LED
- 20. HP Info / HP QuickLook button with LED indicator
- 21. Wireless on/off button with LED indicator
- 22. HP Presentation button with LED indicator
- 23. Ambient Light Sensor
- 24. Two WWAN antennas (with WWAN option)
- 25. Dual-microphone array
- 26. Three WLAN antennas (with WLAN option)
- 27. Optional 2 MP Webcam with LED
- 28. HP NightLight and on/off button

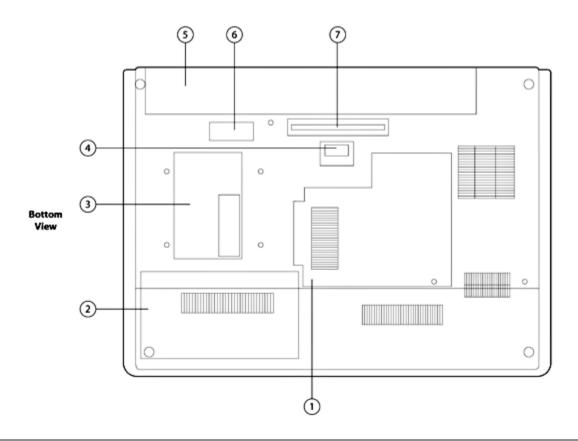


Overview



- 1. (2) USB 2.0 ports
- 2. RJ-45/Ethernet port
- 3. HDMI port
- 4. eSATA port
- 5. 1394a port
- 6. Media Card Reader
- 7. Integrated Smart Card Reader
- 8. ExpressCard/54 slot

- 9. Wireless on/off LED
- 10. Power/standby LED
- 11. Battery charging LED
- 12. Hard drive / optical drive activity / HP 3D DriveGuard LED
- 13. Integrated stereo speakers
- 14. Business Card slot
- 15. Display release latch
- 16. Power connector
- 17. VGA/external monitor connector





Overview

- 1. Memory module and WLAN compartment
- 2. Hard drive bay
- 3. Business card holder
- 4. Secondary battery connector

NOTE: WWAN module compartment is accessible under the keyboard.

At A Glance

• Genuine Windows Vista Business 32, Genuine Windows Vista Business 64, Genuine Windows Vista Home Basic, Genuine Windows Vista Business with downgrade to Windows XP Professional custom installed, or FreeDOS

5.

6.

7.

Battery bay

Battery release latch

Docking connector

- NVIDIA Quadro FX 770M graphics with up to 512 MB dedicated memory, or ATI Mobility FireGL V5700 graphics with up to 256 MB dedicated memory
- DirectX 10 support and Dual Link DVI (available through optional docking) provides faster rendering capabilities and support for ultra-high resolution monitors
- Intel® Centrino® 2 with vPro[™] technology capable, with Intel Core[™]2 Extreme or Intel Core[™]2 Duo processors
- Designed to travel, with weight starting at 6.3 lb/2.86 kg and 1.1-inch/28.2 mm thin at front
- Business Rugged designed to meet the military standard Mil-Std-810F for dust and high temperature storage*
- HP Performance Tuning Framework for optimal configuration, compatibility and performance
- Flexible wireless connectivity options:
 - Integrated HP un2400 EV-DO/HSDPA Mobile Broadband Module provides worldwide Gobi mobile Internet technology
 - Integrated 802.11 a/b/g/draft-n, or a/b/g wireless LAN module
 - Bluetooth®
- HDMI high definition video/audio port
- eSATA connector for external optical drive, hard drive, or RAID array
- Upgrade Bay for easy optical drive upgrade or optional second hard drive for RAID 1 Mirroring or RAID 0 Striping
- Optional Blu-Ray DVD+/-RW SuperMulti DL Drive
- Widescreen 15.4-inch diagonal display with wide-viewing angle (select models), Ambient Light Sensor and HP Privacy Filter support
- Integrated Media Card Reader
- Enhanced security features including integrated Smart Card Reader, HP ProtectTools, HP SpareKey, HP Fingerprint Sensor, TP/ 1.2 Embedded Security Chip**
- Optional 2 MP Webcam with Business Card Reader Software
- HP QuickLook 2 for instant access to email, calendar, and contact information
- Enhanced reliability with HP DuraCase, HP DuraKeys and HP DuraFinish
- Up to 8 GB of 800 MHz DDR2 SDRAM supported, dual channel memory support
- Up to 320 GB 7200 rpm or 250 GB 5400 rpm SMART SATA II user-removable hard drive with HP 3D DriveGuard protection, or 80-GB Solid State Drive
- Integrated Intel Gigabit Network Connection (10/100/1000 NIC)
- Enhanced dual pointing devices (touchpad with scroll zone and pointstick)

* Testing was not intended to demonstrate fitness for DOD contracts requirements or for military use. Test results are not a guarante of future performance under these test conditions.

** TPM module disabled where not permitted by law (for example, Russia and China).



Chipset	Mobile Intel PM45 Ex	xpress Chipset ICH9M-Enhanced	
	[†] Windows Vista Business disk also included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.		
	* Certain Windows Vista product features require advanced or additional hardware. See: http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor.		
	Certified	SuSE Linux Enterprise Desktop 10	
	Supported	Genuine Windows XP Professional 32 Genuine Windows XP Professional 64	
Operating System	Preinstalled	Genuine Windows Vista Business 32* Genuine Windows Vista Business 64* Genuine Windows Vista Home Basic Genuine Windows Vista Business with downgrade to Windows XP Professional custom installed*† FreeDOS	
Processors	Intel Core 2 Extreme F Intel Core 2 Quad Pro Intel Core 2 Duo Proc Intel Core 2 Duo Proc Intel Core 2 Duo Proc Intel Core 2 Duo Proc * Intel's numbering is	Processor QX9300 (2.53 GHz, 12 MB L2 cache, 1066 MHz FSB)* Processor X9100 (3.06 GHz, 6 MB L2 cache, 1066 MHz FSB)* pocessor Q9100 (2.26 GHz, 12 MB L2 cache, 1066 MHz FSB)* essor T9600 (2.80 GHz, 6 MB L2 cache, 1066 MHz FSB)* essor T9400 (2.53 GHz, 6 MB L2 cache, 1066 MHz FSB)* essor P8600 (2.40 GHz, 3 MB L2 cache, 1066 MHz FSB)* essor P8400 (2.26 GHz, 3 MB L2 cache, 1066 MHz FSB)* not a measurement of higher performance. eed denotes maximum performance mode; processors will run at lower speeds in mode.	



Intel Centrino 2 with technology capable	vPlrdel Centrino 2 with vPro technology is a selectable feature that is available on units configured with an Intel WiFi Link 5300 or 5100. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel Active Management Technology (AMT) offers built-in manageability and proactive security for networked notebook PCs, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the operating system, isolate infected systems, and update PCs regardless of their power state.		
		ows operating system, network hardware and software, connection with a power ct (non-VPN) corporate network connection which is either cable or wireless LAN.	
	NOTE: Some functionality of Intel Centrino 2 and vPro technology, such as Intel Active Management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Centrino 2 and vPro technology is dependant on 3rd party software providers. Compatibility with future "virtual appliances" and Microsoft Windows Vista operating system is yet to be determined.		
Business Rugged	Meets the military s	standard Mil-Std-810F* for:	
	 High Tempe Dust: Mathematical 	rature (Storage) d 510.4, Proc. I (Blowing Dust)	
	* Testing was not	intended to demonstrate fitness for DOD contracts requirements or for military use. Te:	
	results are not a gu	uarantee of future performance under these test conditions.	
Graphics	Models with NVIDIA graphics: NVIDIA Quadro FX 770M with 512 MB of dedicated video memory Microsoft DirectX 10 (Shader 4.0) and OpenGL 2.1 capable		
		aphics: ireGL V5700 with 256 MB of dedicated video memory :tX 10.1 (Shader 4.1) and OpenGL 2.1 capable	
Display	Internal	15.4-inch diagonal WXGA anti-glare (1280 x 800 resolution) 15.4-inch diagonal WSXGA+ anti-glare (1680 x 1050 resolution) 15.4-inch diagonal WUXGA+ anti-glare (1920 x 1200 resolution) Ambient light sensor Integrated lid switch HP Privacy Filter support	
	External	Up to 32-bit per pixel color depth VGA port supports resolutions up to 2048 x 1536 at 75 Hz, and lower resolutions at up to 100 Hz HDMI 1.3 port supports direct connection to high-definition displays with up to 1920 x 1080 resolution and 7-channel audio with one convenient cable (not included). DVI port in optional HP Docking Station (sold separately) supports resolutions up to 1920 x 1200 for single-link DVI monitors and up to 2560 x 1600 for dual-link DVI monitors. NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.	



Memory	Standard	800 MHz DDR2 SDRAM; two slots supporting dual channel memory 1024 MB, 2048 MB, 4096 MB, or 8192 MB		
	Maximum	Upgradeable to 8192 MB with 4096 MB SODIMMs in slots 1 and 2		
	Dual-channel	Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.		
	NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HI branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lowe memory speed. Availability of 4 GB or more of memory requires Windows Vista Business 64-bit or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.			
Communications	Integrated Intel Gigabit Ne 56K V.92 modem**	etwork Connection (10/100/1000 NIC)*		
	Gigabit Ethernet, and does	00" or "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for s not connote actual operating speed of 1 Gb/s. For high-speed transmission, thernet server and network infrastructure is required.		
	** Designed for downloads from 56K modem compliant sources. Maximum achievable download transmission rates currently do not reach 56 KB/s, and will vary with line conditions. Modem availability is subject to country regulatory approval.			
Wireless Devices	support for the latest indust be added later. Broadband Professional and is availab option to be added later. I	e of secure, integrated wireless LAN and wireless WAN options featuring ry standards. Wireless LAN is factory configurable or available as an option to d Wireless (WWAN) requires Windows Vista Business or Windows XP de in select countries as a standard, factory configurable feature or as an integrated Bluetooth is also available (factory configurable only) and can be supported wireless LAN and wireless WAN options.		
	HP un2400 EV-DO/HSPA Mobile Broadband Module	Integrated WWAN module with Gobi global mobile Internet technology that provides worldwide connection to both CDMA (EVDO) and UMTS (HSPA) wireless networks. NOTE: Separately purchased mobile network operator service is required. Two 850/900/1800/1900/2100 MHz antennas integrated in the top of the display panel support current and future WWAN technologies.		
	All 802.11 integrated wireless LAN options	Wi-Fi CERTIFIED* Cisco Compatible Extensions support Wired Equivalent Privacy (WEP) support up to 128-bit keys Wi-Fi Protected Access (WPA) and WPA2 support 802.1x authentication support, including EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, and LEAP Advanced Encryption Standard (AES) support		
	Intel WiFi Link 5300	Three antennas integrated in the display enclosure Integrated support for 802.11a, b, g, and n draft 2.0*		
		Up to 450 mbps data rate		
	Intel WiFi Link 5100	Integrated support for 802.11 a, b g, and n draft 2.0* Up to 300 mbps data rate		
	0	Bluetooth Specification v2.0 compliant sWorks with a wide range of Bluetooth devices		



Standard Features				
	specifications differ from t	he draft specifications, it m N devices. In countries whe	specifications and are not final. If the final hay affect the ability of the notebook to communicate ere n draft 2.0 is not allowed, this capability is not	
Keyboard	The 101/102-key compatible keyboard features an industry standard, full-pitch key layout with desktop keyboard features, such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, and 12 function keys. US and International key layouts are available. Other features include an integrated numeric keypad, hotkeys for instant access to power conservation, brightness, and other features, 19-mm x 19-mm key pitch (center-to-center spacing), 2.5-mm stroke, and comfort-dished keycaps.			
	HP DuraKeys is a clear coating applied over the notebook keyboard that helps protect the finish and the printed characters on the keys. HP DuraFinish helps protect the finish on the keyboard deck, graphics, and icons from normal wear and tear.			
Touch-sensitive contro	•		ollowing features: HP Info Center, HP QuickLook, ume up, volume down, and mute	
Pointing device	Enhanced dual pointing de Touchpad with scroll zone and Pointstick, three pick butto	e, three pick buttons		
Expansion card slots	•	PC/SC interface suppor Supports SD (Secure Digi	16 compliant Smart Cards	
Storage	Internal Storage Devic	ce120/160/250 GB 540	00 rpm SMART SATA II Hard Drive 00 rpm SMART SATA II Hard Drive	
	NOTE: Hard drives are customer removable and will withstand multiple insertion/removal cycles. Up to 10 GB is reserved for the system recovery software.			
	HP 3D DriveGuard	The hard drive is mounte transmission of shock aw detection with intelligent normal use from shock ar	d directly to the notebook frame, reducing the ay from the hard drive. Uses three-axis digital motion sensitivity to help protect the hard drive during and vibration. The digital accelerometer temporarily d parks the hard drive when abrupt motion is	
	Upgrade Bay	Fixed 12.7 mm SATA optical drive	Blu-ray R/RE DVD+/-RW SuperMulti DL Drive DVD+/-RW SuperMulti DL LightScribe Drive DVD-ROM Drive	
		or		



Standard Features

HP EliteBook 8530w Mobile Workstatio

Second hard drive*

250 GB 5400 rpm SMART SATA II Hard Drive 250/320 GB 7200 rpm SMART SATA II Hard Drive

* For RAID configurations, both hard drive capacities must be equal.

Interfaces	ExpressCard/54 slot Smart Card Reader Media Card Reader External Monitor 1394a Stereo microphone in Stereo headphone/lin	One One One One – VGA One – 4-pin connector One e One
	out Power connector RJ-11/modem RJ-45/Ethernet HDMI eSATA USB 2.0 Docking connector Secondary battery	One One One – 1.3 compatible One Four One One
	connector LED status indicators	Fifteen
Audio/Visual	High Definition Audio supp Integrated stereo speaker Integrated dual-microphon Touch-sensitive controls fo Stereo headphone/line of Stereo microphone in	rs e array r volume up, volume down, and mute
	Optional 2 MP Webcam	with Business Card Reader Software
	 Large image sensor Up to 30 frames/s AutoMacro focus le Video capture at VC 	



Standard Features				
Software	Preinstalled software wtttP Recovery Manager (Vista only)			
	Windows Vista or	HP Help and Support Center		
	Windows XP	HP QuickLook 2		
		HP Universal Print Driver		
		HP ProtectTools Security Manager:		
		BIOS Configuration for HP ProtectTools		
		Credential Manager for HP ProtectTools		
		Device Access Manager for HP ProtectTools		
		Drive Encryption for HP ProtectTools		
		Embedded Security for HP ProtectTools File Sanitizer for HP ProtectTools		
		Privacy Manager for HP ProtectTools		
		HP Quick Launch Buttons		
		HP Wireless Assistant		
		Microsoft Office Ready with 60-day Office Professional 2007 Trial Edition		
		(select models)		
		PDF Complete Special Edition		
		Intervideo WinDVD - DVD Player		
		Roxio Creator Business (for optional DVD+/-RW and DVD/CD-RW drives)		
		McAfee Total Protection*		
		Synaptics Touchpad Driver		
		Microsoft Windows Live Messenger (select models)		
		HP Webcam Software		
	Additional software HP SoftPaq Download Manager available from the web HP Client Manager Software			
	HP Client Management Solutions			
		Java Card Security for HP ProtectTools		
	1	or McAfee Total Protection for Small Business software. Internet access required to pdate included. Subscription required for updates thereafter.		
Workstation ISV	MCAD	AutoDesk AutoCAD		
Certifications				
Cermications	(Mechanical	AutoDesk Inventor		
Cerimications	(Mechanica) CAD/Architectural	AutoDesk Inventor AutoDesk Revit		
Cernications				
Centrications	CAD/Architectural	AutoDesk Revit		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5 ICEM Surf		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5 ICEM Surf Intelligent Light		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5 ICEM Surf Intelligent Light MSC Software MSC.Patran		
Centralions	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5 ICEM Surf Intelligent Light MSC Software MSC.Patran MSC Software SimXpert		
Centrations	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5 ICEM Surf Intelligent Light MSC Software MSC.Patran MSC Software SimXpert PTC Pro/ENGINEER Wildfire		
Centrications	CAD/Architectural Engineering and	AutoDesk Revit AutoDesk AliasStudio AutoDesk Map 3D AutoDesk Civil 3D Bentley InRoads XM Bentley Microstation Bentley Navigator CEI CoCreate OneSpace Dassault Systemes CATIA V5 ICEM Surf Intelligent Light MSC Software MSC.Patran MSC Software SimXpert		



		Siemans PLMS Solid Edge Siemans PLMS TeamCenter Visualization Solidworks
	DCC (Digital Content Creation)	Adobe Premiere Adobe After effects Adobe Encore Adobe Photoshop AutoDesk 3DS MAX/Combustion AutoDesk Maya
	GIS	Avid Xpress Pro Avid Media Composer SoftImage XSI ESRI ArcGIS
	(Geographic Information Systems)	
	Oil and Gas	Landmark R5000 Paradigm EPOS, GoCAD Schlumberger / GeoFrame Schlumberger Petrel SeismicMicro Technology
HP Performance Tuning Framework	delivering stability and bes	amework (PTF) enables optimal configuration of HP Mobile Workstations at performance. HP PTF will guide your system setup allowing a "custom" tches the workstation to user requirements.
HP Recovery Manager (Vista only)	factory preinstalled image	HP Recovery Manager. HP Recovery Manager enables fast recovery of the if the system becomes corrupted or if important system files are accidentally the hard drive is reserved for the system recovery software.
SMBIOS Version 2.4	System Management BIOS information.	S, previously known as DMI BIOS, is used to store system management
HP ProtectTools Securi Manager	ProtectTools Security Mana	Nanager is the security platform for business notebooks and desktops. The HP ager is an extensible client security console that delivers enhanced security In software modules. Modules currently available are:
	 Drive Encryption for File Sanitizer for HP Set-up Wizard for H 	er for HP ProtectTools lager for HP ProtectTools HP ProtectTools ProtectTools HP ProtectTools r HP ProtectTools (Chat & Sign) for HP ProtectTools



Security	Standard Features	HP ProtectTools Security Manager Enhanced Pre-Boot Security HP SpareKey One-Step Logon HP Fingerprint Sensor Integrated Smart Card Reader Configuration Control Hardware Memory Change Alert Ownership Tag Setup Password Power-On Password Power-On Password TPM 1.2 Embedded Security Chip* TPM Enhanced DriveLock* HP Disk Sanitizer HP 3D DriveGuard Kensington Lock Slot Support for Computrace / LoJack for Laptops (must be purchased separately)		
	Optional Features	HP Privacy Filter Narrows viewing area so that screen data is visible only to persons directly in front of the monitor		
	* TPM module disabled where use is restricted by law; for example, Russia and China. For more information on HP security solutions refer to: http://www.hp.com/go/security.			
Power Supply	Total length including exte HP Fast Charge* *HP Fast Charge recharg	rt AC adapter, 6-foot (1.8-meter) power cord included. ernal AC adapter is 12 feet (3.66 meter). ges your battery up to 90% within 90 minutes when the system is off. HP Fast o 12-cell Ultra-Capacity batteries.		
Battery	Primary battery Optional HP Extended Battery	8-cell (73 WHr) Lithium-Ion battery d L &e ell (52 WHr) high capacity Lithium-Ion battery		



Battery Life	Primary batteryUp to TBD hoursPrimary battery andUp to TBD hours		
	optional HP Extended Life Battery		
	Primary battery and Up to TBD hours optional HP Ultra- Capacity Battery		
	NOTE: The listed battery life measurements were taken on models running Microsoft Windows XP Professional. Battery life will vary depending on the product configuration, product model, applications loaded on the product, power management settings of the product, and the product features used by the customer. As with all batteries, the maximum capacity of this battery will decrease with time and usage.		
System Standby Time	Up to TBD weeks		
Power Conservation	NVIDIA PowerMizer 7.0 technology (models with NVIDIA graphics)		
	ATI PowerPlay technology (models with ATI graphics)		
	Hibernation Standby		
	Standby ACPI compliance		
	· 		
Docking and Stands	HP Advanced Docking Station		
	HP Docking Station HP Standard Monitor Stand		
	HP Adjustable Notebook Stand		
	HP External MultiBay II		
	HP's shared docking solutions provide simple and convenient port replication and cable management. Features include Gigabit NIC pass through, modem pass through, legacy parallel and serial ports, Dual Link DVI-D, USB 2.0 ports, integrated security mechanism [*] , integrated MultiBay II and ExpressCard ^{**} slots. These docking solutions are compatible across multiple Business Notebook platforms enabling a lower total cost of ownership.		
	 * HP/Kensington Cable Lock required (purchased separately) * * HP Advanced Docking Station only 		
Service and Support	HP Services offers limited 3-year, 1-year and 90-day warranty options depending on country; 1-year limited warranty on primary battery. On-site service and warranty upgrades are also available. HP Care Pack Services extend service contracts beyond the standard warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack.		
	NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp		
Select Model(s)	HP's Global Product Offer includes Global Series Preconfigured (GS-P) and Configurable (GS-C) products. GPO delivers globally consistent products, services, and solutions with End-of-Life (EOL) transition management. These products reduce IT complexity, lower management costs, increase productivity, and simplify product transitions.		



Standard Features

8530p FY594AW#xxx	Processor	Intel Core 2 Duo Processor T9400 (2.53 GHz, 6 MB L2 cache, 1066 MHz FSB)	
(for North America, Latin America, Australia, New	Intel Centrino 2 with vPEoabled technology		
Zealand, and Singapore)	Operating System	Genuine Windows Vista Business 32 with Office Ready	
FY595AW#xxx	System Memory	2048 MB 800 MHz DDR2 (1 DIMM)	
(for all regions not listed	Hard Drive	250 GB 7200 rpm SMART SATA II	
above)	Upgrade Bay	DVD+/-RW SuperMulti DL LightScribe Drive	
NOTE: Components may	y Display	15.4-inch diagonal WSXGA+ anti-glare	
vary based on local	Graphics	NVIDIA Quadro FX 770M with 512 MB	
regulatory requirements	Webcam	2 MP Webcam	
	Audio	ADI High Definition CODEC Stereo headphone/line out and microphone in Integrated microphone	
	Communications	Integrated Intel Gigabit Network Connection (10/100/1000 NIC) 56K V.92 modem	
	Integrated Wireless	Intel WiFi Link 5300 (802.11 a/b/g/n draft 2.0)	
	Integrated Security	Drive Encryption for HP ProtectTools HP Fingerprint Sensor TPM 1.2*	
	Pointing Device	Dual pointing devices (Touchpad and Pointstick)	
	Battery	8-cell (73 WHr) Li-Ion	
	Power	External 120W adapter	
	Warranty	3/3/0 or 3/3/3 depending on country	
	* TPM module disabled w	here use is restricted by law; for example, Russia and China.	

* TPM module disabled where use is restricted by law; for example, Russia and China.



Options		
Memory	HP 1 GB (DDR2 800 MHz) SODIMM	KT292AA
	HP 2 GB (DDR2 800 MHz) SODIMM	KT293AA
	HP 4 GB (DDR2 800 MHz) SODIMM	KT294AA
Storage	HP Notebooks USB Diskette Drive	DC361B
	HP 250GB Pocket Media Drive	FE477AA
	HP Primary SATA 120 GB 7200 rpm Hard Drive	AH920AA
	HP Primary SATA 250 GB 5400 rpm Hard Drive	AK072AA
	HP Upgrade Bay SATA 250 GB 5400 rpm Hard Drive	AK868AA
	HP Upgrade Bay SATA DVD+/-RW SuperMulti DL LightScribe Drive	АК869АА
MultiBay II Storage (9.5-mm)	HP MultiBay II DVD-ROM Drive	PA849A
NOTE: Requires HP Advanced Docking Station or HP External MultiBay II	HP MultiBay II DVD+/-RW SuperMulti DL Drive	PA851A
Expansion Solutions	HP Docking Station	EN488AA#xxx
	HP Advanced Docking Station	EN489AA#xxx
	HP 2008 150W Docking Station	KQ751AA#xxx
	HP 2008 180W Advanced Docking Station	KQ752AA#xxx
	HP External MultiBay II	PA509A#xxx
	HP Dual-Monitor Stand	AK084AA
	HP Standard Monitor Stand	PA507A
	HP Adjustable Notebook Stand	PA508A
	HP Mobile Port Replicator	AK155AA
Communications	Intel WiFi Link 5300	KM591AA#xxx
	HP un2400 EVDO/HSUPA Mobile Broadband Module	FN556AA
Power	HP 1-Bay Battery Charging Station	RW635AA#xxx
	HP 5-Bay Battery Charging Station	RW636AA#ABA
	HP Battery Adapter Kit	KV830AA
	HP 150W Smart AC Adapter	AL192AA#xxx
	HP 180W Smart AC Adapter	AK875AA#XXX
	HP 90W Smart Auto Adapter	ED493AA
	HP 90W Smart Combo Adapter	AJ652AA#xxx
	HP Primary 8-cell Battery pack	KU533AA
	HP Extended Life Battery	AJ359AA
	HP 12-cell Ultra-Capacity Battery	EJ092AA



Options		
Carrying Cases	HP Basic Carrying Case	AJ078AA
	HP Value Nylon Case	RR314AA
	HP Universal Nylon Case	RR315AA
	HP Executive Leather Case	RR316AA
	HP Deluxe Nylon Backpack	RR317AA
	HP Deluxe Roller Case	GD405AA
Security	HP ExpressCard Smart Card Reader with Java Card	AJ451AA
	HP ProtectTools Java Card – 10 units	EL348AA
	HP/Kensington MicroSaver Security Lock	PC766A
	HP Privacy Filter	AJ358AA
Input/Output Devices	HP PS/2 Keyboard & Mouse Bundle*	RC464AA#xxx
	HP USB Keyboard & Mouse Bundle	RC465AA#xxx
	HP USB/PS2 Optical 2-Button Scroll Mouse	DC369A
	HP USB Optical Travel Mouse	RH304AA
	* Requires HP Docking Station, HP Advanced Docking Station, HP 2008 Docking Static Advanced Docking Station. Availability may vary by region.	n or HP 2008



Memory

800-MHz DDR2 SDRAM Two DIMM slots supporting dual channel memory DIMM sizes supported: 1024 MB, 2048 MB, and 4096 MB

Standard Memory	 1024 MB (1024 MB × 1)
	• 2048 MB (2048 MB x 1 or 1024 MB x 2)
	• 4096 MB (4096 MB x 1 or 2048 MB x 2)
	 8192 MB (4096 MB x 2)

Optional Memory Upgrades Support for up to 8192 MB of memory with the installation of optional DDR2 SDRAM memory kits. Both memory slots are user accessible. Please refer to the Hardware and Software Guide for installation procedures. Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

Up to	Slot 1	Slot 2
1024 MB	1024 MB	Empty
2048 MB	1024 MB	1024 MB
3072 MB	2048 MB	1024 MB
4096 MB	2048 MB	2048 MB
8192 MB	4096 MB	4096 MB

NOTE: This chart does not represent all possible memory configurations. Due to the non-industry standard nature of some third-party memory modules, we strongly recommend using only HP branded memory modules to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Availability of 4 GB or more of memory requires Windows Vista Busine: 64-bit or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

Memory Upgrades	HP 1 GB (DDR2 800 MHz) SODIMM	KT292AA
	HP 2 GB (DDR2 800 MHz) SODIMM	KT293AA
	HP 4 GB (DDR2 800 MHz) SODIMM	KT294AA



Storage

Upgrade Bay Drive Support

	Quantity Supported	Drive Bay
Blu-ray R/RE DVD+/-RW SuperMulti DL Drive	One	Upgrade Bay
DVD+/-RW SuperMulti DL LightScribe Drive	One	Upgrade Bay
DVD-ROM Drive	One	Upgrade Bay
250 GB 5400 rpm SMART SATA II Hard Drive	One	Upgrade Bay
320 GB 7200 rpm SMART SATA II Hard Drive	One	Upgrade Bay
250 GB 7200 rpm SMART SATA II Hard Drive	One	Upgrade Bay

Internal Storage Device

	Quantity Supported	Drive Bay
Hard Drives		
250 GB 5400 rpm SMART SATA II Hard Drive	One	Dedicated hard drive bay
160 GB 5400 rpm SMART SATA II Hard Drive	One	Dedicated hard drive bay
120 GB 5400 rpm SMART SATA II Hard Drive	One	Dedicated hard drive bay
320 GB 7200 rpm SMART SATA II Hard Drive	One	Dedicated hard drive bay
250 GB 7200 rpm SMART SATA II Hard Drive	One	Dedicated hard drive bay
160 GB 7200 rpm SMART SATA II Hard Drive	One	Dedicated hard drive bay
Solid State Drive		
80 GB Solid State Drive	One	Dedicated hard drive bay



Technical Specifications

System Unit	Dimensions (HxWxD)	1.1 in (at front) x 14.0 in : 28.2 mm (at front) x 355		
	Weight	Starting from 6.3 lb (2.86 kg)		
	NOTE: Height varies de includes 8-cell battery, ha		notebook the measurement is made. Starting weigh 2.11 wireless communications module, Bluetooth, components.	
	Stand-Alone Power	Normal Operating Voltage	e 18.5 V	
	Requirements	Average Operating Powe	r TBD W	
		Max Operating Power	< 120 W	
	Temperature	Operating	32° to 95° F (0° to 35° C) (not writing optical)	
			41° to 95° F (5° to 35° C) (writing optical)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Relative Humidity	Operating	10% to 90%, non-condensing	
		Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature	
	Shock	Operating	125 G, 2 ms, half-sine	
		Non-operating	200 G, 2 ms, half-sine	
	Random Vibration	Operating	0.75 grms	
		Non-operating	1.50 grms	
	Altitude	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
	(unpressurized)	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)	
	Industry Standard	UL	Yes	
	Certifications	CSA	Yes	
		FCC Compliance	Yes	
		energy star®	TBD	
		EPEAT	TBD	
		ICES	Yes	
		GS	Yes	
		Australia / NZ A-Tick Compliance	Yes	
		CCC	Yes	
		Japan VCCI Compliance	Yes	
		MIC	Yes	
		BSMI	Yes	
		CE Marking Compliance	Yes	
		BNCI or BELUS	Yes	
		CIT	Yes	
		GOST	Yes	
		Saudi Arabian Compliance (ICCP)	Yes	
		SABS	Yes	
		UKRSERTCOMPUTER	Yes	

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.



Technical Specifications

HP 120W Smart AC Adapter	Weight	1.52 lb (0.69 kg) (adapt 0.29 lb (0.13 kg) (power		
	Dimensions	6.65 x 2.56 x 1.50 in (1	16.9 x 6.5 x 3.8 cm)	
	Input		100 to 240 VAC	
		Operating Input Current	PFC Version: 2.20 A at 90 VAC 1.10 A at 180 VAC	
			Non-PFC Version: 2.5 A at 110 VAC 1.25 A at 180 VAC	
		Operating Frequency Range	47 to 63 Hz AC	
		Efficiency	83% minimum at 115 VAC	
	Output	Output power	120 W	
		DC Output Voltage	18.5 V	
	Environmental Design	Operating Temperature	32° to 104° F (0° to 35° C)	
		Non-operating (storage) Temperature	–4° to 149° F (–20° to 65° C)	
		Altitude	0 to 10,000 ft (0 to 3,048 m)	
		Humidity	20% to 80%	
		Storage Humidity	10% to 90%	
	EMI and Safety Certifications	CE Mark: full compliance with LVD and EMC directives Worldwide safety standards: IEC60950, EN60950, UL60950, Class2, SELV		
		Agency approvals: C-UL-U Class B, CISPR22 Class B	JS, NORDICS, DENAN, EN55022 Class B, FCC 3, CCC, NOM-1 NYCE, S-Mark, Australian Elect NCI, KONCAR, GS, GOST, SASO, SABS,	
			ics apply to PFC version only.	
Optional HP Ultra-	Dimensions (H x W x L)	1.3 x 6.0 x 10.6 in (3.3	3 x 15.25 x 26.88 cm)	
Capacity Battery	Weight	1.77 lb (0.803 kg)		
	Cells/Type	12-cell Lithium-Ion		
	Energy	Watt-hour Capacity	95 WHr	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (–10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Tim	·	3 to 4 hours	
		System ON	4 to 5 hours (depending on system power consumption)	
	Fuel Gauge	When pressed, LEDs light	indicating level of charge remaining on battery	



Technical Specifica	tions		
Optional HP Extende	d Libernensions (H x W x L)	1.0 x 3.9 x 8.7 in (2.5 x	(10.0 x 22.0 cm)
Battery	Weight	1.00 lb (0.455 kg)	
	Cells/Type	8-cell Lithium-Ion	
	Energy	Watt-hour Capacity	52 WHr
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 140° F (–10° to 60° C)
		Non-operating	-4° to 140° F (-20° to 60° C)
	Battery Re-Charge Tim	neSystem in OFF mode or Standby	3 hours
		System ON	3 to 5 hours (depending on system power consumption)
		HP Fast Charge Technology	Charges the battery up to 90% within 90 minutes when system is OFF
	Fuel Gauge	When pressed, LEDs light	indicating level of charge remaining on battery
8-Cell (73 WHr) Lithi	umÐimensions (H x W x L)	0.8 x 1.9 x 10.6 in (2.0	x 4 8 x 27 0 cm)
lon battery	Weight	0.980 lb (0.445 kg)	
	Cells/Type	8-cell Lithium-Ion	
	Energy	Watt-hour Capacity	73 WHr
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
	·	Operating (Discharging)	14° to 140° F (–10° to 60° C)
		Non-operating	-4° to 140° F (-20° to 60° C)
	Battery Re-Charge Tim	neSystem in OFF mode or Standby	2.5 hours
		System ON	3 to 5 hours (depending on system power consumption)
		HP Fast Charge Technology	Charges the battery up to 90% within 1.5 hours when system is OFF

Displays



Technical Specificati	ons		
15.4-inch WUXGA+, oglare	anDimensions (W x H) Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution Backlight PPI Viewing Angle	13.0 x 8.1 in (33.1 x 2 15.4 in (39.1 cm) Anti-glare 300:1 (typical) 60 Hz 200 nit (typical) Pitch Format Configuration CCFL 147 TBD	20.7 cm) 0.173 mm 1920 x 1200 RGB stripe
15.4-inch WSXGA+ a glare	ntDimensions (W x H) Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution Backlight PPI Viewing Angle	13.0 x 8.1 in (33.1 x 1 15.4 in (39.1 cm) Anti-glare 300:1 (typical) 60 Hz 200 nit (typical) Pitch Format Configuration CCFL 129 TBD	20.7 cm) 0.197 mm 1680 x 1050 RGB stripe
15.4-inch WXGA anti- glare	Active Area (W x H) Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution Backlight PPI Viewing Angle		0.259 mm 1280 x 800 RGB stripe



Technical Specifications

Internal Storage

320 GB 7200 rpm S	SAT B rive Weight	0.25 lbs (115 g)		
Hard Drive	Capacity	320 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 Gk	p/s, NCQ	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)	
	Seek Time	Single Track	1.5 ms	
	(typical reads, including	Average	11 ms	
	settling)	Maximum	22 ms	
	Rotational Speed	7200 rpm		
	Logical Blocks	625,142,448		
	Operating Temperatu	$_{ m vre32^\circ}$ to 140° F (0° to 60°	C) [case temp]	
	Features	ATA Security		
250 GB 7200 rpm S	6	0.25 lbs (115 g)		
Hard Drive	Capacity	250 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ		
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)	
	Seek Time	Single Track	1.5 ms	
	(typical reads, including	Average	11 ms	
	settling)	Maximum	22 ms	
	Rotational Speed	7200 rpm		
	Logical Blocks	488397168		
	Operating Temperatu	$_{ m vre32^\circ}$ to 140° F (0° to 60°	C) [case temp]	
	Features	ATA Security		



Technical Specifications

160 GB 7200 rpm SA	AT B rive Weight	0.25 lb (115 g)		
Hard Drive	Capacity	160 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ		
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)	
	Seek Time	Single Track	1.5 ms	
	(typical reads, including	Average	ll ms	
	settling)	Maximum	22 ms	
	Rotational Speed	7200 rpm		
	Logical Blocks	312,581,808		
	Operating Temperature32° to 140° F (0° to 60° C) [case temp]			
	Features	ATA Security		
250 GB 5400 rpm SA	AT B rive Weight	0.22 lb (101 g)		
250 GB 5400 rpm SA Hard Drive	AT B rive Weight Capacity	0.22 lb (101 g) 250 GB		
	0			
	Capacity	250 GB		
	Capacity Height	250 GB 0.37 in (9.5 mm)	⊳∕s, NCQ	
	Capacity Height Width	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb	o∕s, NCQ 100 MB∕s (Drive Capability)	
	Capacity Height Width Interface Transfer Rate Seek Time	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb		
	Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb Synchronous (maximum)	100 MB/s (Drive Capability)	
	Capacity Height Width Interface Transfer Rate Seek Time	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb Synchronous (maximum) Single Track	100 MB/s (Drive Capability) 3 ms	
	Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb Synchronous (maximum) Single Track Average	100 MB/s (Drive Capability) 3 ms 13 ms	
	Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling)	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb Synchronous (maximum) Single Track Average Maximum	100 MB/s (Drive Capability) 3 ms 13 ms	
	Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling) Rotational Speed Logical Blocks	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb Synchronous (maximum) Single Track Average Maximum 5400 rpm	100 MB/s (Drive Capability) 3 ms 13 ms 24 ms	
	Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling) Rotational Speed Logical Blocks	250 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gb Synchronous (maximum) Single Track Average Maximum 5400 rpm 488,397,168	100 MB/s (Drive Capability) 3 ms 13 ms 24 ms	



Technical Specifica	tions	·				
160 GB 5400 rpm S	SAT B rive Weight	0.22 lb (101 g)				
Hard Drive	Capacity	160 GB				
Height Width	0.37 in (9.5 mm)			0.37 in (9.5 mm) 2.75 in (70 mm)		
	Width					
	Interface	ATA-8, SATA 2.6, 3.0 (Gb/s, NCQ			
	Transfer Rate	Synchronous (maximur	m) 100 MB/s (Drive Capability)			
	Seek Time	Single Track	3 ms			
	(typical reads, including	Average	13 ms			
	settling)	Maximum	24 ms			
	Rotational Speed	5400 rpm				
	Logical Blocks	312,581,808				
	Operating Temperatu	140° F (0° to 60	0° C) [case temp]			
	Features	ATA Security				
120 GB 5400 rpm S	SATBrive Weight	0.22 lb (101 g)				
Hard Drive	Capacity	120 GB				
	Height	0.37 in (9.5 mm)				
	Width	2.75 in (70 mm)				
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ				
	Transfer Rate		m) 100 MB/s (Drive Capability)			
	Seek Time	Single Track	3 ms			
	(typical reads, including	Average	13 ms			
	settling)	Maximum	24 ms			
	Rotational Speed	5400 rpm				
	Logical Blocks	234,441,648				
		ure32° to 140° F (0° to 60	0° C) [case temp]			
	Features	ATA Security				
80 GB 2.5" SATA So	lid\//ciabt					
State Drive	Capacity	80 GB				
	Height	0.37 in (9.5 mm)				
	Width	2.75 in (70 mm)				
	Interface	ATA-7 / SATA 2.6				
			n) 100 MB/s (Drive Capability)			
	Sustained Read / Wr Performance		, , , , , , , , , , , , , , , , , , , ,			
	Logical Blocks	156,301,488				
	0	ure32° to 158°F (0° to 70)°C) [case temp]			
	Features	ATA Security	, .			



Technical Specifications

Optical Drives

DVD-ROM Drive	Access Times	Random	<116 ms CD (typical)			
			<125 ms DVD (typical)			
	Max Data Transfer Rate24X CD-ROM		Up to 3,600 KB/s			
	- () (8X-DVD	Up to 10,800 KB/s			
	Transfer Mode	UDMA Mode 5				
	Interface	Gen 1 SATA				
	Supported Media (reac	Supported Media (read) CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo- CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-RAM				
	Supported Media (write	e)None				
	Max Media Capacity (read)	4.7 GB				
	Transport	Tray Loading				
DVD+/-RW SuperMulti	DAccess Times	Random	<175 ms CD (typical)			
LightScribe Drive			<230 ms DVD (typical)			
	Max Data Transfer Rate24X CD-ROM		Up to 3,600 KB/s			
		8X DVD	Up to 10,800 KB/s			
		24X CD-R	Up to 3,600 KB/s			
		16X CD-RW	Up to 2,400 KB/s			
		8X DVD+R	Up to 10,800 KB/s			
		4X DVD+RW	Up to 5,400 KB/s			
		8X DVD-R	Up to 10,800 KB/s			
		4X DVD-RW	Up to 5,400 KB/s			
		2.4X DVD+R(9)	Up to 2,700 KB/s			
		5X DVD-RAM	Up to 6,750 KB/s			
	Transfer Mode	UDMA Mode 5				
	Interface	Gen 1 SATA				
		l) CD-DA, CD+(E)G, CD-MI MODE CD, CD-I, CD-I Bri CD, CD-EXTRA, Portfolio, (DI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED idge (Photo-CD, Video CD), Multisession CD (Photo- CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-RAM			
	Supported Media (write)CD-R, CD-RW, DVD+R, DVD+RW, DVD-RW, DVD-RAM, LightScribe					
	Max Media Capacity (read)					
	Max Media Capacity (write)	8.5 GB				
	Transport	Tray Loading				



Technical Specificati	ions		
Blu-ray R/RE DVD+/-R\ SuperMulti DL Drive	WAccess Times	Random	<140 ms CD-ROM (typical) <160 ms DVD-ROM (typical) <300 ms BD-ROM (typical)
	Max Data Transfer Rate24X CD-ROM		Up to 3,600 KB/s
		8X DVD-ROM	Up to 10,800 KB/s
		8X CD-R	Up to 1,200 KB/s
		8X CD-RW	Up to 1,200 KB/s
		8X DVD+R	Up to 10,800 KB/s
		4X DVD+RW	Up to 5,400 KB/s
		8X DVD-R	Up to 10,800 KB/s
		4X DVD-RW	Up to 5,400 KB/s
		2.4X DVD+R(9)	Up to 2,700 KB/s
		5X DVD-RAM	Up to 6,750 KB/s
		1 X BD-ROM	Up to 4,500 KB/s
		1 X BD-R	Up to 4,500 KB/s
		1 X BD-RE	Up to 4,500 KB/s
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read	MODE CD, CD-I, CD-I BI CD, CD-EXTRA, Portfolio,	IDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED idge (Photo-CD, Video CD), Multisession CD (Photo- CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, , DVD-R, DVD-RW, DVD+R, DVD+RW. DVD-RAM,
	Supported Media (write	e)CD-R, CD-RW, DVD+R, D DVD-RAM, BD-R, BD-RE	VD+R(9), DVD+RW, DVD-R, DVD-R(9), DVD-RW,
	Max Media Capacity (read)	50.0 GB	
	Max Media Capacity (write)	50.0 GB	
	Transport	Tray Loading	

Security



Technical Specification	ons				
HP Fingerprint Sensor	Mobile Voltage Opera	tiðr0V–3.6V Single Supply			
	Operating Temperature32° – 158°F (0° – 70°C)				
	Current Consumption 6 3.3V	Pless than 70 mA peak imaging and scrolling Less than 25 mA hardware finger detection Advanced Power Management			
	High-Rate Image Capt	utep to 240 image frames /sec			
	ESD Resistance	IEC 61000-4-2 Level 4 (±15KV)			
	Detection Matrix	192 x 16 Pixels			
		9.7 mm x 0.81 mm			
		500 ppi High-Resolution Images			
Audio					
Hardware	Implementation	ADI1984A High Definition CODEC			
	Volume Controls	Volume up, volume down, and mute			
	Full Duplex	Yes			
	Sound Blaster Pro	Yes			
	compatible				
	Microphone In	Stereo			
	Headphone/Line Out	Stereo			
	Integrated Microphone	e Yes			
Audio Output Quality	Frequency Response	20 Hz – 20 kHz			
1 /		>85 dB			
	Total Harmonic Distorti@.01%				
		–110 dB			
	Play/Record Sampling Rate(s)				
	DAC	16, 20 or 24-bit			
	ADC	16, 20 or 24-bit			
Integrated Stereo	Power Rating	2 Watts			
Speakers	Impedance	4 Ohms			

Communications



Technical Specificati	ions		
Integrated Intel Gigat Network Connection (10/100/1000 NIC)	bitEthernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30)	
82567LM		1000 Mbit/s operation (1000BASE-T; IEEE 802.3z and 802.3ab; IEEE 802.3 clauses 34-42)	
		Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)	
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption	
	Performance Features	TCP/IP/UDP Checksum Offload (configurable)	
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot	
		Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))	
		Comprehensive diagnostic and configuration software suite Intel Advanced Management Technology (iAMT)	
	Interface	PCI Express x1	
	NIC Device Driver Namletel 82567 Gigabit Network Connection		
V.92 56K Data/Fax	Form Factor	MDC 1.5 Daughtercard	
Modem	Power Management Support	APM Revision 1.2, ACPI	
	Approvals/ Certifications	UL, CSA, NEMKO, CCIB, Industry Canada, FCC Part 68, CTR21, FCC Par 15 Class B, Canadian ICES-003 Class B, C.I.S.P.R.22, Australian ACA, CE Mark, Other Countries	
	Data Mode Capabilitie	esV.92 data	
		V.8bis	
		V.80	
		V44, V.42bis, MNP5 (Compression)	
		V.42 (LAPM, MNP2-4) (Error Correction)	
		Optional symbol rates: 2800, 3429 Asymmetric Symbol rates	
		Synchronous primary channel data signaling rates: 3600, 31200	
		Automatic rate re-negotiation	
		V.34	
		V.32bis	
		V.32 V.23	
		V.22bis	
		V.22	
		V.21	
		Bell 212A	



Technical Specifications

	Fax Mode Capabilities	Bell 103J TIA/EIA-578-B (Class 1) T.30, T.4 (Group 3) V.17 V.29 V.27ter V.21 Channel 2 V.250 (Partial) TIA-602 Identification: +GMI, +GMM, +GMR Port control: +IPR, +ICF, +IFC, +ILRR Modulation: +MS, +MR, +MA Error control: +ES, +ER, +EB, +ESR, +ETBM Data compression: +DS, +DR V.251
HP un2400 EV-DO/HSPA Mobile Broadband Module	Technology/Operating Bands	GSM/GPRS/EDGE: 850MHz(Cell), 900MHz(EGSM), 1800MHz(DCS), 1900MHz (PCS) UMTS/WCDMA with receive diversity: 2100MHz (UTRA FDD Band I), 1900MHz (UTRA FDD Band II), 850MHz (UTRA FDD Band V) 1xEVDO/1xRTT with receive diversity: 850MHz (Band ClassO-Cell), 1900MHz (Band Class1-PCS)
	Wireless Protocol Standards	GSM/GPRS/EDGE: Class B, Multi-slot operation, coding schemes CS1 – CS4 and MSC1 – MSC9. UMTS/WCDMA: Release 99 and Release 5 CDMA: 1xEVDO Release 0 and Release A, IS-95A, IS-95B, IS-2000
	Wireless Parametric Standards	Meets or exceeds TIA/EIA IS-98-D
	Maximum Data Rates	UMTS (HSPA) – 7.2 Mbps (Download), 2.0Mbps (Upload) CDMA (EVDO Release A) – 3.1 Mbps (Download), 1.8Mbps (Upload)
	Maximum Output Powe	eGSM/GPRS/EDGE: 32dBm (+/-1) WCDMA: 24dBm (+/-1) CDMA: 24dBm (+/-1)
	Maximum Power Consumption	2500mA (peak); 1000mA (average)
	Power Consumption, Sleep Mode	5 mA
	Power Management	USB selective suspend Integrated notebook wireless button
	Antenna Type	Dual high efficiency 5 band antennae with spatial diversity, mounted in the display enclosure
	Form Factor	PCI-Express MiniCard
	Weight	11.5 g
	Dimensions (Length x Width x Thickness)	2.01 x 1.18 x 0.18 in (51 x 30 x 4.5 mm)
	Voltage, Operating	3.3v +/- 10%
• / •	Temperature, Operatir (from TIA/EIA/IS-98-D)	ng-22° to 140° F (–30° to 60° C) (full RF performance) –22° to 167° F (–30° to 75° C) (reduced RF performance)



Technical Specificat	tions			
	Temperature, Non- operating, 96 hours (fr MIL-STD 202 Method 108)	–40° to 185° F (–40° to 85° C) om		
	Humidity, Non-operatin@5% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)			
	Configuration Utilities			
	LED Activity	LED Off – Radio Off; Solid LED On – Radio On		
Intel WiFi Link 5300	Wireless LAN Standard			
Intel VVIPI LINK 3300	vvireiess LAIN Standard	IEEE 802.11b IEEE 802.11g IEEE 802.11n (draft 2.0)*		
		* The specifications for 802.11n draft 2.0 are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11n WLAN devices. In countries where n draft 2.0 is not allowed, this capability is not enabled.		
	Interoperability	Wi-Fi certified (802.11abg only) Cisco Compatible Extensions Program compliant (802.11abg only) with Microsoft Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN) Tested with wireless access points from several major manufacturers (details at: http://www.hp.com/go/notebooks/WLAN/draft-n)		
	Frequency Band	2.4 GHz and 5 GHz		
	Antenna Structure	3 transmit; 3 receive (3x3)		
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n (draft): 66 possible data rates, ranging from 6 Mbps to 450 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n (draft) specification		
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM		
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128, 192, and 256 bits), 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST.		
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows Vista and XP only.		
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.		
	Media Access Protoco	I CSMA/CA (Collision Avoidance) with ACK		
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)		
	Roaming	IEEE 802.11 compliant roaming between access points		
	Output Power (for CCK) ² 15 dBm			



Technical Specifications

Output Power (for OFD power varies by data rate) ²	M}5 dBm		
Power Consumption	Transmit: 2.3 Watts (average, with three spatial streams) Receive: 1.9 Watts (average with three receive chains) Idle mode ³ : 30 mW (average) Radio off: 20 mW (max)		
Power Management	ACPI compliant power r 802.11 compliant powe	5	
Receiver Sensitivity ⁴	300 Mbps: -68 dBm, 5	4 Mbps: -74 dBm, 6 Mbps: -90 dBm	
Antenna Connections	3 U.FL type connectors,	50 ohm nominal impedance	
Range	802.11 a – Typical (@6 Mbps)	600 feet – Outdoor Open Area 150 feet – Indoor, Office environment	
	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
Form Factor	PCI-Express MiniCard		
Weight	0.013 lb (6 g)		
Dimensions	0.19 x 1.2 x 2.0 in (4.	75 x 29.85 x 50.8 mm)	
Operating Voltage	3.3V +/- 9%, 1.5V +/-	5%	
Temperature	Operating 32° to 176° F (0° to 80° C) Non-operating -40° to 176° F (-40° to 80° C)		
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 90% (non-condensing)	
Altitude	Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)		
Configuration Utility ⁵	Microsoft Windows XP Choice of Configuration Utility:		
		ws XP Wireless Network Connection Manager Aicrosoft Windows XP (required for Cisco Compatible t)	
	Microsoft Windows Vist	a	
		ws Vista Wireless Network Connection Manager. ns for Windows Vista available to support Cisco sions.	
LED Activity	LED Off – Radio OFF; Solid LED On – Radio ON		
 Maximum output pc In Power Save Pollin Receiver sensitivity in packet error rate of WLAN supplier's cl 	ower may vary by country ng mode and on battery p is measured at a packet e 10% for 802.11a/g (Ol ient utility is required for C	rror rate of 8% for 802.11b (CCK modulation) and a FDM modulation). Fisco Compatible Extensions support with Microsoft	
		e with certain third-party software supplicants. WLAN popatible Extensions support for Microsoft Windows	



Technical Specifications

Vista.

Intel WiFi Link 5100	Wireless LAN Standard			
		IEEE 802.11b IEEE 802.11g		
		IEEE 802.11n (draft 2.0)*		
		* The specifications for 802.11n draft 2.0 are draft specifications and are		
		not final. If the final specifications differ from the draft specifications, it may		
		affect the ability of the notebook to communicate with other 802.11n WLAN		
		devices. In countries where n draft 2.0 is not allowed, this capability is not		
		enabled.		
	Interoperability	Wi-Fi certified (802.11abg only)		
		Cisco Compatible Extensions Program compliant (802.11abg only) with		
		Microsoft Windows Vista and XP (details at:		
		http://www.hp.com/go/notebooks/WLAN)		
		Tested with wireless access points from several major manufacturers		
		(details at: http://www.hp.com/go/notebooks/WLAN/draft-n)		
	Frequency Band	2.4 GHz and 5 GHz		
	Antenna Structure	1 transmit; 2 receive (1x2)		
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps		
		802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n (draft): 66 possible data rates, ranging from 6 Mbps to 300		
		Mbps, depending on the combination of Bandwidth, Modulation Coding		
		Scheme, and Guard Interval used, as defined in IEEE 802.11n (draft)		
		specification		
	Modulation	Direct Sequence Spread Spectrum		
		DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM		
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES		
		(support for key sizes of 128, 192, and 256 bits), 802.1x authentication		
		types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST.		
		Support for Cisco Security Features (proven compatibility with Cisco Aironet		
		infrastructure products through the Cisco Compatible Extensions Program		
		Version 4) with Microsoft Windows Vista and XP only.		
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.		
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK		
	Network Architecture	Ad-hoc (Peer to Peer)		
	Models	Infrastructure (Access Point Required)		
	Roaming	IEEE 802.11 compliant roaming between access points		
	Output Power (for CCK) ² 15 dBm			
	Output Power (for OFD)	√} 5 dBm		
	power varies by data rate) ²			
	Power Consumption	Transmit: 2.3 Watts (average, with one spatial streams)		
		Receive: 1.9 Watts (average with two receive chains)		
		Idle mode ³ : 30 mW (average)		
		Radio off: 20 mW (max)		



Technical Specifications

er Management	ACPI compliant power management 802.11 compliant power saving mode		
eiver Sensitivity ⁴	300 Mbps: -68 dBm, 54 Mbps: -74 dBm, 6 Mbps: -90 dBm		
enna Connections	3 U.FL type connectors,	50 ohm nominal impedance	
ge	802.11 a – Typical (@6 Mbps)	600 feet – Outdoor Open Area 150 feet – Indoor, Office environment	
	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
n Factor	PCI-Express MiniCard		
ight	0.013 lb (6 g)		
ensions	0.19 x 1.2 x 2.0 in (4.1	75 x 29.85 x 50.8 mm)	
erating Voltage	3.3V +/- 9%, 1.5V +/-	5%	
TemperatureOperating32° to 176° F (0° to 80° C)Non-operating-40° to 176° F (-40° to 80° C)		32° to 176° F (0° to 80° C) –40° to 176° F (–40° to 80° C)	
nidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 90% (non-condensing)	
ude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
figuration Utility ⁵	Microsoft Windows XP Choice of Configurat	ion Utility:	
	 Intel PROSet for M 	vs XP Wireless Network Connection Manager Aicrosoft Windows XP (required for Cisco Compatible t)	
	Microsoft Windows Visto		
	 Intel IHV extension 	vs Vista Wireless Network Connection Manager. ns for Windows Vista available to support Cisco sions.	
Activity	LED Off – Radio OFF; Sc	olid LED On – Radio ON	
Maximum output po	wer may vary by country	according to local regulations.	
Receiver sensitivity i packet error rate of WLAN supplier's cli Windows XP. WLA	s measured at a packet e 10% for 802.11a/g (Of ent utility is required for C N may also be compatible	rror rate of 8% for 802.11b (CCK modulation) and a	
	eiver Sensitivity ⁴ enna Connections ge n Factor ght ensions erating Voltage perature hidity ude figuration Utility ⁵ Activity Check latest softwa Maximum output po In Power Save Pollir Receiver sensitivity i packet error rate of WLAN supplier's cli Windows XP. WLAI supplier IHV extensit	802.11 compliant powe eiver Sensitivity ⁴ 300 Mbps: -68 dBm, 5- 3 U.FL type connectors, ge 802.11 a – Typical (@6 Mbps) 802.11 b – Typical (@1 Mbps) 802.11 g –	

HP Integrated Module Bluetooth Specification 2.0 Compliant with Bluetooth Wireless Dimensions $1.02 \times 0.55 \times 0.22$ in (26 x 14 x 5.7 mm) Technology 2402 to 2480 MHz Frequency Band



Technical Specifications

Number of Available Channels	79 (1 MHz) available channels		
Data Rates and	3 Mbps data rate; throughput up to 2.17 Mbps		
Throughput	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels		
	Asynchronous Connectio or 1306.9 kbps symme	n Less links 2178.1 kbps/177.1 kbps asymmetric ric	
Transmit Power	-6 dBm to 4 dBm (Blueto	ooth Class II)	
Receiver Sensitivity	Better than -80 dBM at	0.1 % raw bit error rate	
Power Consumption	Peak (Tx) 264 mW		
	Peak (Rx) 231 mW		
	Sleep <1 mW		
Antenna	Internally integrated with	in module	
Range	Up 33 ft (10 m)		
Electrical Interface	USB 2.0 compliant		
	Microsoft Windows Plug	and Play compliant	
OS Support	Microsoft Windows XP F	rofessional and Home	
	Microsoft Windows 200	00	
Bluetooth Software	Broadcom Bluetooth for	Windows	
Supported	Microsoft Windows XP	Bluetooth Software	
Link Topology	Point to Point, Multipoint	Pico Nets up to 7 slaves	
Security	Full support of Bluetooth	Security Provisions	
Power Management	Microsoft Windows ACPI, and USB Bus Support		
	Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff		
Certifications	All necessary regulatory approvals for supported countries, including		
	FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
	ETS 300 328, ETS 300	826	
	Low Voltage Directive IE	C950	
	UL, CSA, and CE Mark		
Temperature	Operating	–4° to 158° F (–20° to 70° C)	
	Non-operating	–40° to 176° F (–40° to 80° C)	
Humidity	Operating	10% to 90%	
	Non-operating	5% to 95%	
Altitude	Operating	15,000 ft (4,572 m)	
	Non-operating	40,000 ft (12,192 m)	
Bluetooth Profiles	(with Bluetooth for Windows 4.0 software)		
Supported	Serial Port Profile (SPP)*	Serial Port Profile (SPP)*	
	Dial-Up Networking (DUI	√)*	
	Generic Object Exchang		
	Object Push Profile (OPP)*	
File Transfer Profile (FTP) Synchronization Profile (SYNC)			
	Hard Copy Cable Replacement (HCRP)*		



Technical Specif	fications				
		Personal Area Networking	Profile (PAN)*		
		Human Interface Device Pro			
		FAX Profile (FAX)			
		Basic Imaging Profile (BIP)			
		Headset Profile (HSP)			
		Hands Free Profile (HFP)			
		Advanced Audio Distribution	n Profile (A2DP)		
	* indicates the profile is al	so supported by Microsoft W	/indows XP SP2		
Eco Data	Eco-Label Certification	s This product has received c following approvals and ma		f being certified to the one or more of these marks:	
		 US Energy Star Taiwan Green Mark China Energy Conse IT ECO declaration EPEAT - Silver 	rvation Program		
		 Korea ECO label 			
	System Configuration	The configuration used for t Emissions data for the Conv "Typically Configured Notel	vertible Mini tower [ition and Declared Noise Desktop model is based on a	
	Energy Consumption	115 VAC	230 VAC	100 VAC	
	Normal Operation	15.22 W	17.02 W	15.12 W	
	Sleep (Energy Star low power mode)	1.278 W	1.335 W	1.271 W	
	Off	0.647 W	0.636 W	0.724 W	
	Heat Dissipation*	115 VAC	230 VAC	100 VAC	
	Normal Operation	52 BTU/hr	58 BTU/hr	52 BTU/hr	
	Sleep	4 BTU/hr	5 BTU/hr	4 BTU/hr	
	Off	2 BTU/hr	2 BTU/hr	3 BTU/hr	
		* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.			
		This product is in complianc on LAN) disabled.	e with US executive	order 13221, WOL (wake	
	Declared Noise Emissio (in accordance with ISO 7779 and ISO 9296)	ons			
	System Fan Off	Sound Power (LWAd, bels)		Sound Pressure (LpAm, decibels)	
	Idle	3.1		23	
	Fixed Disk (random writes)	3.1		24	
	· · · · · · · · · · · · · · · · · · ·	cept when charging the bat	tery		



Technical Specifications		
Batteries	This product complies with ISO standards:	
	 EU Directive 91/157/EEC EU Directive 93/86/EEC EU Directive 98/101/EEC 	
	Batteries used in the product do not contain:	
	 Mercury greater the 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 4000 ppm by weight. 	
	The battery type and chemistry used in the product is: CR2032 (coin cell), Lithium This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.	
Additional information:	This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.	
	This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).	
	This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level, see: www.epeat.net	
	Keyboard complies with ISO standard: ISO 9995, EN 29241-4, and ISO/IEC 15412	
	Input devices of this product comply with ISO 9241, part 9.	
	Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.	
	This product contains 0% recycled materials (by wt.)	
	This product is greater than 95.0% recycle-able when properly disposed of at end of life.	
	Packaging Materials	
	 External: Polyethylene low density 13 g Corrugated carton 236 g Internal: Corrugated 280 g The EPE foam packaging material is made from 100% recycled content. The corrugated paper packaging materials contains at least 80% recycled content. 	
	HP follows these guidelines to decrease the environmental impact of product packaging:	



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Technical Specifications

Material Usage

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the

Environment (http://www.hp.com/hpinfo/globalcitizenship/environment/ supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

End-of-life ManagementHewlett-Packard offers end-of-life HP product return and recycling programs in and Recycling many geographic areas. To recycle your product, please go to:

http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in c responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. Th information (product disassembly instructions) is posted on the Hewlett



Technical Specifications

	Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate Environme	nt&lobal Citizenship Report
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Environment website
	http://www.hp.com/environment
	Eco-label certifications
	http://www.hp.com/hpinfo/globalcitizenship/environment/
	productdesign/ecolabels.html
	ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/ operations/envmanagement.html

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